

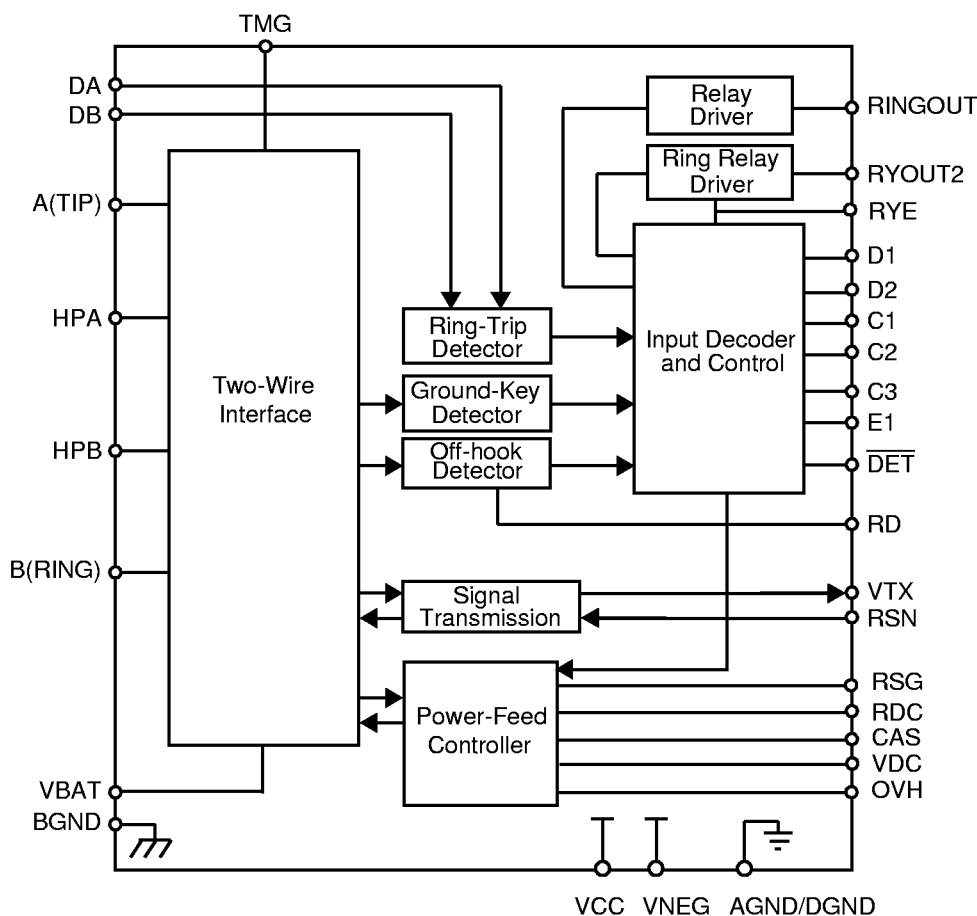
# Am7946

## Subscriber Line Interface Circuit

### DISTINCTIVE CHARACTERISTICS

- Ideal for long loop applications
- On-hook transmission
- -40 V to -58 V battery operation
- On-hook transmission
- Internal  $V_{EE}$  regulator
- Low standby power
- On-chip Thermal Management (TMG) feature
- Scaled line voltage (VAB) output
- Logic selectable for 2.2 V metering or long loop feed
- Two-wire impedance set by scaled external impedance
- Programmable constant-current feed
- Programmable loop-detect threshold
- Current gain = 500
- Ground-key detector
- Tip Open state for ground-start lines
- Polarity reversal option available
- Three on-chip relay drivers and snubber circuits (32-PLCC only)

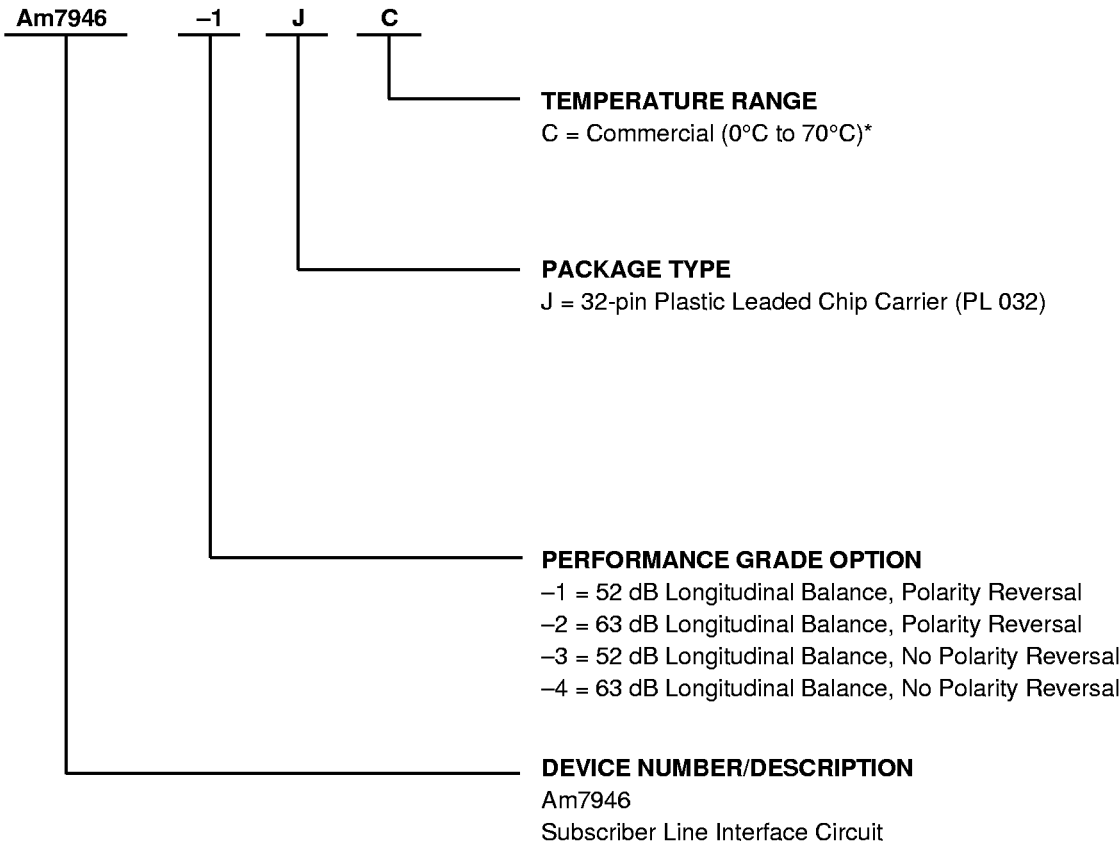
### BLOCK DIAGRAM



ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.



| Valid Combinations |    |    |
|--------------------|----|----|
| Am7946             | -1 | JC |
|                    | -2 |    |
|                    | -3 |    |
|                    | -4 |    |

Valid Combinations

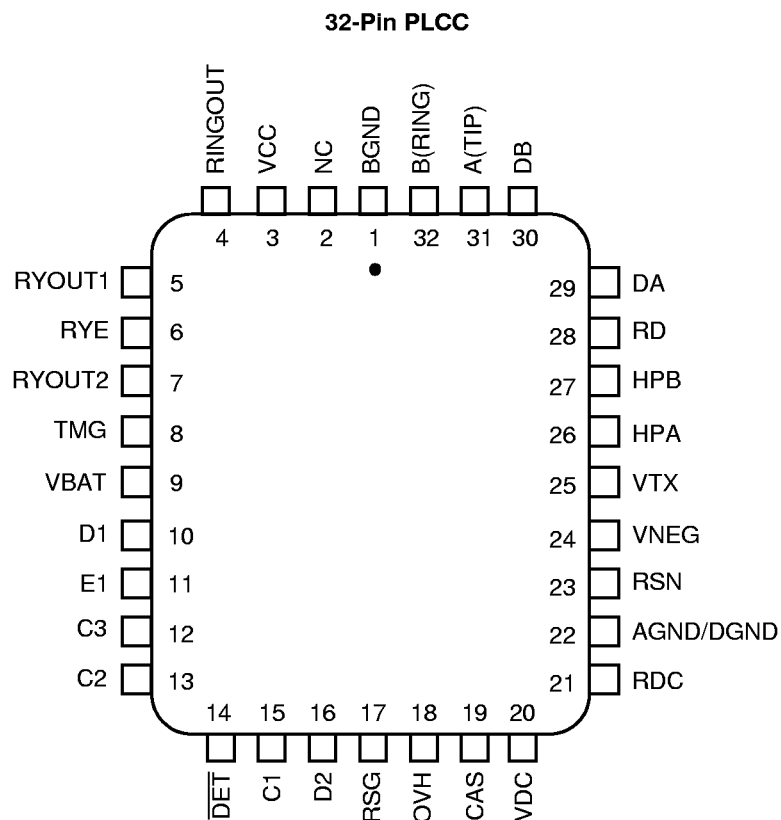
Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

Note:

\* Functionality of the device from 0°C to +70°C is guaranteed by production testing. Performance from -40°C to +85°C is guaranteed by characterization and periodic sampling of production units.

# CONNECTION DIAGRAMS

## Top View



**Notes:**

1. Pin 1 is marked for orientation.
2. NC = No Connect

## PIN DESCRIPTIONS

| Pin Names      | Type      | Description                                                                                                                                                                                                                                        |
|----------------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AGND/DGND      | Gnd       | Analog and digital ground.                                                                                                                                                                                                                         |
| A(TIP)         | Output    | Output of A(TIP) power amplifier.                                                                                                                                                                                                                  |
| BGND           | Gnd       | Battery (power) ground.                                                                                                                                                                                                                            |
| B(RING)        | Output    | Output of B(RING) power amplifier.                                                                                                                                                                                                                 |
| C3–C1          | Inputs    | Decoder. SLIC control pins. C3 is MSB and C1 is LSB. TTL compatible.                                                                                                                                                                               |
| CAS            | Capacitor | Anti-Saturation pin for capacitor to filter reference voltage when operating in anti-saturation region.                                                                                                                                            |
| D2–D1          | Input     | Relay Driver Control. D2–D1 control the relay drivers RYOUT1 and RYOUT2. A logic Low on D1 activates the RYOUT1 relay driver. A logic Low on D2 activates the RYOUT2 relay driver. TTL compatible.                                                 |
| DA             | Input     | Ring-Trip Negative. Negative input to ring-trip comparator.                                                                                                                                                                                        |
| DB             | Input     | Ring-Trip Positive. Positive input to ring-trip comparator.                                                                                                                                                                                        |
| DET            | Output    | Switchhook Detector. When enabled, a logic Low indicates that a selected condition is detected. The detect condition is selected by the logic inputs (C3–C1 and E1). The output is open collector with a built-in 15 k $\Omega$ pull-up resistor.  |
| E1             | Input     | Ground-Key enable. A logic High selects the off-hook detector. A logic Low selects the ground-key detector. TTL compatible.                                                                                                                        |
| HPA            | Capacitor | High-pass filter capacitor. A(TIP) side of the high-pass filter capacitor.                                                                                                                                                                         |
| HPB            | Capacitor | High-pass filter capacitor. B(RING) side of the high-pass filter capacitor.                                                                                                                                                                        |
| OVH            | Input     | Overhead voltage control. A logic High enables nonmetering overhead. A logic Low enables 2.2 V metering DC overhead. TTL compatible.                                                                                                               |
| RD             | Resistor  | Detect resistor. Detector threshold set and filter pin.                                                                                                                                                                                            |
| RDC            | Resistor  | DC feed resistor. Connection point for the DC feed current programming network. The other end of the network connects to the receiver summing node (RSN). The sign of $V_{RDC}$ is negative for normal polarity and positive for reverse polarity. |
| RINGOUT        | Output    | Ring relay driver. Open collector driver with emitter internally connected to BGND. This is activated in the ringing state.                                                                                                                        |
| RSG            | Input     | Saturation guard. A resistor from this pin to ground allows the saturation cut in voltage to be increased while maintaining AC transmission overhead voltage.                                                                                      |
| RSN            | Input     | Receive summing node. The metallic current (both AC and DC) between A(TIP) and B(RING) is equal to 500 times the current into this pin. The networks which program receive gain, two-wire impedance, and feed resistance all connect to this node. |
| RYE            | Output    | Common emitter of RYOUT1/2. Emitter output of RYOUT1 and RYOUT2. Normally connected to relay ground.                                                                                                                                               |
| RYOUT1, RYOUT2 | Output    | (Option) Relay/Switch driver. Open collector driver with emitter internally connected to RYE.                                                                                                                                                      |
| TMG            | —         | Thermal management. An external resistor connects between this pin and VBAT to offload power dissipation from the Am7946 SLIC. Functions during Normal Polarity and Reverse Polarity states.                                                       |
| VBAT           | Battery   | Battery supply and connection to substrate.                                                                                                                                                                                                        |
| VCC            | Power     | +5 V power supply.                                                                                                                                                                                                                                 |
| VDC            | Output    | Scaled VAB output. $V_{DC} =  (V_{AB} / 20) $ . Range of 0 V to 2.5 V. This output is filtered by $C_{HP}$ .                                                                                                                                       |
| VNEG           | Power     | –4.75 V to VBAT negative supply. This pin is the return for the internal VEE regulator.                                                                                                                                                            |
| VTX            | Output    | Transmit audio. The voltage at this output is equal to the metallic voltage across A(TIP) and B(RING). VTX also sources the two-wire input impedance programming network.                                                                          |

## ABSOLUTE MAXIMUM RATINGS

|                                                                                           |                                   |
|-------------------------------------------------------------------------------------------|-----------------------------------|
| Storage temperature .....                                                                 | –55°C to +150°C                   |
| V <sub>CC</sub> with respect to AGND/DGND .....                                           | –0.4 V to +7.0 V                  |
| V <sub>NEG</sub> with respect to AGND/DGND .....                                          | +0.4 V to V <sub>BAT</sub>        |
| V <sub>BAT</sub> with respect to AGND/DGND:                                               |                                   |
| Continuous .....                                                                          | +0.4 V to –80 V                   |
| 10 ms .....                                                                               | +0.4 V to –85 V                   |
| BGND with respect to AGND/DGND .....                                                      | +3 V to –3 V                      |
| A(TIP) or B(RING) to BGND:                                                                |                                   |
| Continuous .....                                                                          | –70 V to +1 V                     |
| 10 ms (f = 0.1 Hz) .....                                                                  | –70 V to +5 V                     |
| 1 μs (f = 0.1 Hz) .....                                                                   | –80 V to +8 V                     |
| 250 ns (f = 0.1 Hz) .....                                                                 | –90 V to +12 V                    |
| Current from A(TIP) or B(RING) .....                                                      | ±150 mA                           |
| RINGOUT or RYOUT1 or RYOUT2 current .....                                                 | 75 mA                             |
| RINGOUT voltage .....                                                                     | BGND to +7 V                      |
| RINGOUT transient .....                                                                   | BGND to +10 V                     |
| RYE voltage .....                                                                         | BGND to V <sub>BAT</sub>          |
| RYOUT1 or RYOUT2 voltage .....                                                            | RYE to +7 V                       |
| RYOUT1 or RYOUT2 transient .....                                                          | RYE to +10 V                      |
| DA and DB inputs                                                                          |                                   |
| Voltage on ring-trip inputs .....                                                         | V <sub>BAT</sub> to 0 V           |
| Current into ring-trip inputs .....                                                       | ±10 mA                            |
| C3–C1, D2–D1, E1, OVH                                                                     |                                   |
| Input voltage .....                                                                       | –0.4 V to V <sub>CC</sub> + 0.4 V |
| Maximum power dissipation, continuous,<br>T <sub>A</sub> = 85°C, No heat sink (See note): |                                   |
| In 32-pin PLCC package .....                                                              | 1.33 W                            |
| Thermal Data .....                                                                        | θ <sub>JA</sub>                   |
| In 32-pin PLCC package .....                                                              | 45°C/W typ                        |

**Note:** Thermal limiting circuitry on chip will shut down the circuit at a junction temperature of about 165°C. The device should never see this temperature and operation above 145°C junction temperature may degrade device reliability. See the SLIC Packaging Considerations for more information.

*Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.*

## OPERATING RANGES

### Commercial (C) Device

|                                         |                             |
|-----------------------------------------|-----------------------------|
| Ambient temperature .....               | 0°C to +70°C*               |
| V <sub>CC</sub> .....                   | +4.75 V to +5.25 V          |
| V <sub>NEG</sub> .....                  | –4.75 V to V <sub>BAT</sub> |
| V <sub>BAT</sub> .....                  | –40 V to –58 V              |
| AGND/DGND .....                         | 0 V                         |
| BGND with respect to<br>AGND/DGND ..... | –100 mV to +100 mV          |
| Load resistance on VTX to ground .....  | 20 kΩ min                   |

*The Operating Ranges define those limits between which the functionality of the device is guaranteed.*

*\* Functionality of the device from 0°C to +70°C is guaranteed by production testing. Performance from –40°C to +85°C is guaranteed by characterization and periodic sampling of production units.*

## ELECTRICAL CHARACTERISTICS

| Description                                                          | Test Conditions (See Note 1)                     | Min        | Typ        | Max        | Unit  | Note   |   |
|----------------------------------------------------------------------|--------------------------------------------------|------------|------------|------------|-------|--------|---|
| V <sub>VTX</sub> , Analog output offset voltage                      | 0 °C to +70 °C<br>–40 °C to +85 °C               | –35<br>–40 |            | +35<br>+40 | mV    | —<br>4 |   |
| Overload level, 2-wire                                               | Active state, OVH = High                         | 2.5        |            |            | Vpk   | 2a     |   |
| Overload level, 2-wire                                               | Active state, OVH = Low                          | 6.0        |            |            |       |        |   |
| Overload level                                                       | On hook, R <sub>LAC</sub> = 600 Ω,<br>OVH = High | 1.06       |            |            | Vrms  | 2b     |   |
| Total Harmonic Distortion (THD)                                      | 0 dBm<br>+7 dBm                                  |            | –64<br>–55 | –50<br>–40 | dB    |        |   |
| THD, On hook                                                         | 0 dBm, R <sub>LAC</sub> = 600 Ω                  |            |            | –36        |       | 5      |   |
| Longitudinal Performance (See Test Circuit C)                        |                                                  |            |            |            |       |        |   |
| Longitudinal to metallic<br>L-T, L-4 balance                         | 200 Hz to 1 kHz:                                 | –1, –3*    | 52         |            | dB    | 4      |   |
|                                                                      | Normal polarity                                  | –2, –4     | 63         |            |       |        |   |
|                                                                      | Reverse polarity                                 | –2         | 58         |            |       |        |   |
|                                                                      | Normal polarity,<br>–40 °C to +85 °C             | –2, –4     | 58         |            |       |        |   |
|                                                                      | 1 kHz to 3.4 kHz:                                | –1, –3*    | 52         |            |       | 4      |   |
|                                                                      | Normal polarity                                  | –2, –4     | 58         |            |       |        |   |
|                                                                      | Reverse polarity                                 | –2         | 54         |            |       |        |   |
|                                                                      | Normal polarity,<br>–40 °C to +85 °C             | –2, –4     | 54         |            |       |        |   |
| Longitudinal signal generation 4-L                                   | 200 Hz to 800 Hz normal polarity                 | 40         |            |            |       |        |   |
| Longitudinal current per pin (A or B)                                | Active or OHT state                              | 27         | 35         |            | mArms |        |   |
| Longitudinal impedance at A or B                                     | 0 to 100 Hz                                      |            | 10         | 35         | Ω/pin |        |   |
| Idle Channel Noise                                                   |                                                  |            |            |            |       |        |   |
| C-message weighted noise                                             | R <sub>LDC</sub> = 600 Ω +25 °C to +85 °C        |            | +7         | +10        | dBmC  | —      |   |
|                                                                      | R <sub>LDC</sub> = 600 Ω –40 °C to +25 °C        |            |            | +12        |       | 4      |   |
| Psophometric weighted noise                                          | R <sub>LDC</sub> = 600 Ω +25 °C to +85 °C        |            | –83        | –80        | dBmp  | —      |   |
|                                                                      | R <sub>LDC</sub> = 600 Ω –40 °C to +25 °C        |            |            | –78        |       | 4      |   |
| Insertion Loss and Balance Return Signal (See Test Circuits A and B) |                                                  |            |            |            |       |        |   |
| Gain accuracy<br>2- to 4-wire, 4- to 4-wire                          | 0 dBm, 1 kHz, nonmetering                        | –6.22      | –6.02      | –5.82      | dB    | 4      |   |
|                                                                      | 0 dBm, 1 kHz, 2.2 V metering                     | –6.12      | –5.92      | –5.72      |       |        |   |
|                                                                      | On hook, OHT                                     | –6.37      | –6.02      | –5.67      |       |        |   |
| Gain accuracy<br>4- to 2-wire                                        | 0 dBm, 1 kHz, nonmetering                        | –0.20      | 0          | +0.20      |       |        |   |
|                                                                      | 0 dBm, 1 kHz, 2.2 V metering                     | –0.20      | 0          | +0.20      |       |        |   |
|                                                                      | On hook, OHT                                     | –0.35      | 0          | +0.35      |       |        |   |
| Gain accuracy over frequency                                         | 300 to 3400 Hz 0 °C to +70 °C                    | –0.10      |            | +0.10      |       |        | 4 |
|                                                                      | relative to 1 kHz –40 °C to +85 °C               | –0.15      |            | +0.15      |       |        |   |
| Gain tracking<br>Relative to 0 dBm                                   | +3 dBm to –55 dBm 0 °C to +70 °C                 | –0.10      |            | +0.10      |       |        |   |
|                                                                      | –40 °C to +85 °C                                 | –0.15      |            | +0.15      |       |        |   |
| Gain tracking, on hook, OHT<br>Relative to 0 dBm                     | 0 dBm to –37 dBm 0 °C to +70 °C                  | –0.10      |            | +0.10      | 4     |        |   |
|                                                                      | –40 °C to +85 °C                                 | –0.15      |            | +0.15      |       |        |   |
|                                                                      | +3 dBm to 0 dBm                                  | –0.35      |            | +0.35      |       |        |   |
| Group delay                                                          | 0 dBm, 1 kHz                                     |            | 3          |            | μs    | 4, 6   |   |

**Note:**

\* Performance Grade

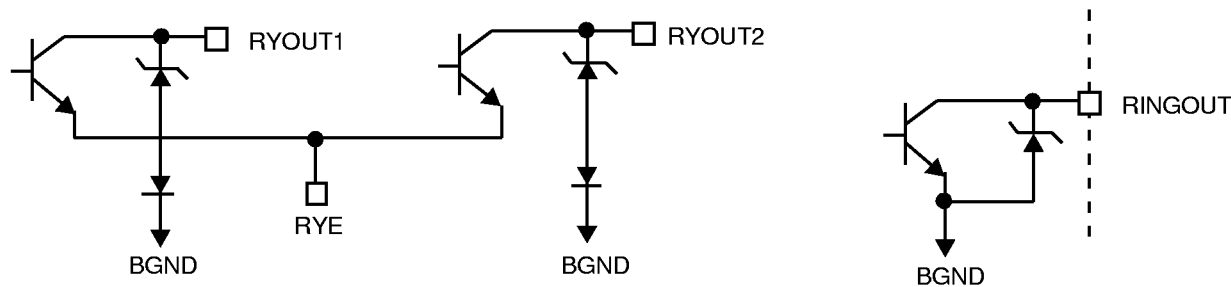
**ELECTRICAL CHARACTERISTICS (continued)**

| Line Characteristics                                                                 |                                                                                |                     |                |                     |       |   |
|--------------------------------------------------------------------------------------|--------------------------------------------------------------------------------|---------------------|----------------|---------------------|-------|---|
| I <sub>L</sub> , Loop-current accuracy                                               | I <sub>L</sub> in constant-current region                                      | 0.915I <sub>L</sub> | I <sub>L</sub> | 1.085I <sub>L</sub> | mA    |   |
| I <sub>L</sub> , Long loops, Active state                                            | R <sub>LDC</sub> = 1840 Ω, V <sub>BAT</sub> = −50 V, OVH = Low                 | 20.5                |                |                     |       |   |
|                                                                                      | R <sub>LDC</sub> = 2030 Ω, V <sub>BAT</sub> = −50 V, OVH = High                | 20.5                |                |                     |       |   |
| I <sub>L</sub> , Accuracy, Standby state                                             | $I_L = \frac{ V_{BAT}  - 3 \text{ V}}{R_L + 400} \quad T_A = 25^\circ\text{C}$ | 0.8I <sub>L</sub>   | I <sub>L</sub> | 1.2I <sub>L</sub>   |       |   |
|                                                                                      | Constant-current region                                                        | 16                  | 22             | 39                  |       |   |
| I <sub>L</sub> LIM                                                                   | Active, A and B to ground<br>OHT, A and B to ground                            |                     | 100<br>50      | 130                 |       | 4 |
| I <sub>L</sub> , Open Circuit state                                                  | R <sub>L</sub> = 0 Ω                                                           |                     |                | 100                 | μA    |   |
| I <sub>A</sub> , pin A leakage, Tip Open state                                       | R <sub>L</sub> = 0 Ω                                                           |                     |                | 100                 |       |   |
| I <sub>B</sub> , pin B current, Tip Open state                                       | B to ground<br>B to V <sub>BAT</sub> + 6 V                                     |                     | 26<br>15       |                     | mA    |   |
| V <sub>A</sub> , Standby state, ground-start signaling                               | A to −48 V = 7 kΩ,<br>B to ground = 100 Ω                                      | −7.5                | −5             |                     | V     | 4 |
| V <sub>AB</sub> , Open Circuit voltage                                               | BAT = −50 V                                                                    | 42.75               | 44.5           |                     |       | 8 |
| Power Supply Rejection Ratio (V <sub>RI</sub> PPLE = 100 mVrms), Active Normal State |                                                                                |                     |                |                     |       |   |
| V <sub>CC</sub>                                                                      | 50 Hz to 3.4 kHz                                                               | 30                  | 40             |                     | dB    | 5 |
| V <sub>NEG</sub>                                                                     | 50 Hz to 3.4 kHz                                                               | 30                  | 50             |                     |       |   |
| V <sub>BAT</sub>                                                                     | 50 Hz to 3.4 kHz                                                               | 28                  | 55             |                     |       |   |
| Effective internal resistance                                                        | CAS pin to ground                                                              | 85                  | 170            | 255                 | kΩ    | 4 |
| Power Dissipation                                                                    |                                                                                |                     |                |                     |       |   |
| On hook, Open Circuit state                                                          |                                                                                |                     | 30             | 70                  | mW    |   |
| On hook, Standby state                                                               |                                                                                |                     | 60             | 85                  |       |   |
| On hook, OHT state                                                                   |                                                                                |                     | 120            | 180                 |       |   |
| On hook, Active state                                                                | R <sub>TMG</sub> = 2.5 kΩ                                                      |                     | 180            | 270                 |       |   |
| Off hook, Standby state                                                              |                                                                                |                     | 860            | 1300                |       |   |
| Off hook, Active state                                                               | R <sub>L</sub> = 300 Ω, R <sub>TMG</sub> = 2.5 kΩ                              |                     | 550            | 800                 |       |   |
| Supply Currents, Battery = −58 V                                                     |                                                                                |                     |                |                     |       |   |
| I <sub>CC</sub> ,<br>On-hook V <sub>CC</sub> supply current                          | Open Circuit state                                                             |                     | 2.7            | 3.8                 | mA    |   |
|                                                                                      | Standby state                                                                  |                     | 3.3            | 4.4                 |       |   |
|                                                                                      | OHT state                                                                      |                     | 4.9            | 7.5                 |       |   |
|                                                                                      | Active normal state                                                            |                     | 6.3            | 8.5                 |       |   |
| I <sub>NEG</sub> ,<br>On-hook V <sub>NEG</sub> supply current                        | Open Circuit state                                                             |                     | 0              | 0.1                 |       |   |
|                                                                                      | Standby state                                                                  |                     | 0              | 0.1                 |       |   |
|                                                                                      | OHT state                                                                      |                     | 0.70           | 1.1                 |       |   |
|                                                                                      | Active normal state                                                            |                     | 0.70           | 1.1                 |       |   |
| I <sub>BAT</sub> ,<br>On-hook V <sub>BAT</sub> supply current                        | Open Circuit state                                                             |                     | 0.35           | 1.0                 |       |   |
|                                                                                      | Standby state                                                                  |                     | 1.0            | 1.5                 |       |   |
|                                                                                      | OHT state                                                                      |                     | 1.9            | 4.7                 |       |   |
|                                                                                      | Active normal state                                                            |                     | 3.0            | 5.7                 |       |   |
| RFI Rejection                                                                        |                                                                                |                     |                |                     |       |   |
| RFI rejection                                                                        | 100 kHz to 30 MHz, (See Figure F)                                              |                     |                | 1.0                 | mVrms | 4 |

ELECTRICAL CHARACTERISTICS (continued)

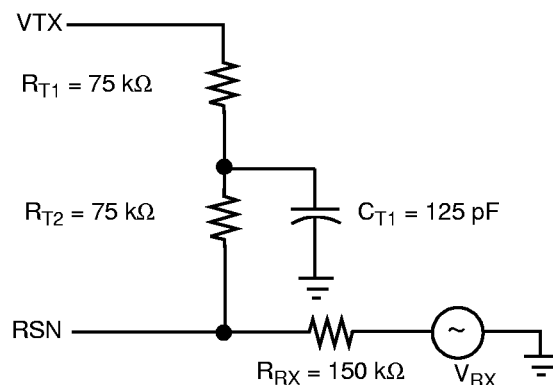
| Logic Inputs (C3–C1, D2–D1, E1, OVH)              |                                         |                    |                    |                    |    |   |
|---------------------------------------------------|-----------------------------------------|--------------------|--------------------|--------------------|----|---|
| V <sub>IH</sub> , Input High voltage              |                                         | 2.0                |                    |                    | V  |   |
| V <sub>IL</sub> , Input Low voltage               |                                         |                    |                    | 0.8                |    |   |
| I <sub>IH</sub> , Input High current              |                                         | –75                |                    | 40                 | μA |   |
| I <sub>IL</sub> , Input Low current               |                                         | –400               |                    |                    |    |   |
| Logic Output (DET)                                |                                         |                    |                    |                    |    |   |
| V <sub>OL</sub> , Output Low voltage              | I <sub>OUT</sub> = 10 mA                |                    |                    | 1.0                | V  |   |
| V <sub>OL</sub> , Output Low voltage              | I <sub>OUT</sub> = 0.8 mA               |                    |                    | 0.40               |    |   |
| V <sub>OH</sub> , Output High voltage             | I <sub>OUT</sub> = –0.1 mA              | 2.4                |                    |                    |    |   |
| Ring-Trip Detector Input (DA, DB)                 |                                         |                    |                    |                    |    |   |
| Bias current                                      |                                         | –500               | –50                |                    | nA |   |
| Offset voltage                                    | Source resistance = 2 MΩ                | –50                | 0                  | +50                | mV | 6 |
| Loop Detector                                     |                                         |                    |                    |                    |    |   |
| I <sub>T</sub> , Loop-detect threshold            | R <sub>D</sub> = 35.4 kΩ, Active state  | 330/R <sub>D</sub> | 375/R <sub>D</sub> | 420/R <sub>D</sub> | mA |   |
|                                                   | R <sub>D</sub> = 35.4 kΩ, Standby state | 380/R <sub>D</sub> | 430/R <sub>D</sub> | 480/R <sub>D</sub> |    |   |
| Ground-Key Detector Thresholds                    |                                         |                    |                    |                    |    |   |
| Ground-key resistive threshold                    | B to ground                             | 2                  | 5                  | 10                 | kΩ |   |
| Ground-key current threshold                      | B to ground                             |                    | 10                 |                    | mA |   |
| Relay Driver Output (RYOUT1, RYOUT2, and RINGOUT) |                                         |                    |                    |                    |    |   |
| V <sub>OL</sub> , On voltage (each output)        | I <sub>OL</sub> = 30 mA                 |                    | +0.25              | +0.4               | V  | 4 |
| V <sub>OL</sub> , On voltage (each output)        | I <sub>OL</sub> = 40 mA                 |                    | +0.35              | +0.6               |    |   |
| I <sub>OH</sub> , Off leakage (each output)       | V <sub>OH</sub> = +5 V                  |                    |                    | 100                | μA |   |
| Zener breakover (each output)                     | I <sub>Z</sub> = 100 μA                 | 6.6                | 7.9                |                    | V  |   |
| Zener On voltage (each output)                    | I <sub>Z</sub> = 30 mA                  |                    | 11                 |                    |    |   |

RELAY DRIVER SCHEMATICS



**Notes:**

1. Unless otherwise noted, test conditions are  $BAT = -52\text{ V}$ ,  $V_{CC} = +5\text{ V}$ ,  $V_{NEG} = -5\text{ V}$ ,  $R_L = 600\ \Omega$ ,  $R_{DC1} = R_{DC2} = 28.4\text{ k}\Omega$ ,  $R_D = 35.4\text{ k}\Omega$ ,  $R_{SG} = 0\ \Omega$  to GND,  $R_{TMG} = 2.5\text{ k}\Omega$ , no fuse resistors,  $C_{HP} = 0.22\ \mu\text{F}$ ,  $C_{DC} = 0.1\ \mu\text{F}$ ,  $C_{CAS} = 0.1\ \mu\text{F}$ ,  $D1 = 1\text{N400X}$ , two-wire AC input impedance is a  $600\ \Omega$  resistance synthesized by the programming network shown below.



2. a. Overload level is defined when  $THD = 1\%$ .  
b. Overload level is defined when  $THD = 1.5\%$ .
3. Balance return signal is the signal generated at  $V_{TX}$  by  $V_{RX}$ . This specification assumes that the two-wire AC load impedance matches the programmed impedance.
4. Not tested in production. This parameter is guaranteed by characterization or correlation to other tests.
5. This parameter is tested at  $1\text{ kHz}$  in production. Performance at other frequencies is guaranteed by characterization.
6. Tested with  $0\ \Omega$  source impedance.  $2\text{ M}\Omega$  is specified for system design only.
7. Group delay can be greatly reduced by using a  $Z_T$  network such as that shown in Note 1 above. The network reduces the group delay to less than  $2\ \mu\text{s}$  and increases  $2WRL$ . The effect of group delay on linecard performance also may be compensated for by synthesizing complex impedance with the QSLAC™ or DSLAC™ device.
8. If  $|BAT|$  drops below  $50\text{ V}$ , the VAB voltage tracks the battery to preserve transmission capability. Open-circuit VAB can be modified using  $R_{SG}$ .

**Table 1. SLIC Decoding**

| State | C3 | C2 | C1 | Two-Wire Status          | (DET) Output  |            |
|-------|----|----|----|--------------------------|---------------|------------|
|       |    |    |    |                          | E1 = 1        | E1 = 0     |
| 0     | 0  | 0  | 0  | Open Circuit             | Ring trip     | Ring trip  |
| 1     | 0  | 0  | 1  | Ring                     | Ring trip     | Ring trip  |
| 2     | 0  | 1  | 0  | Active                   | Loop detector | Ground key |
| 3     | 0  | 1  | 1  | On-hook TX (OHT)         | Loop detector | Ground key |
| 4     | 1  | 0  | 0  | Tip Open                 | Loop detector | Ground key |
| 5     | 1  | 0  | 1  | Standby                  | Loop detector | Ground key |
| 6     | 1  | 1  | 0  | Active Polarity Reversal | Loop detector | Ground key |
| 7     | 1  | 1  | 1  | OHT Polarity Reversal    | Loop detector | Ground key |

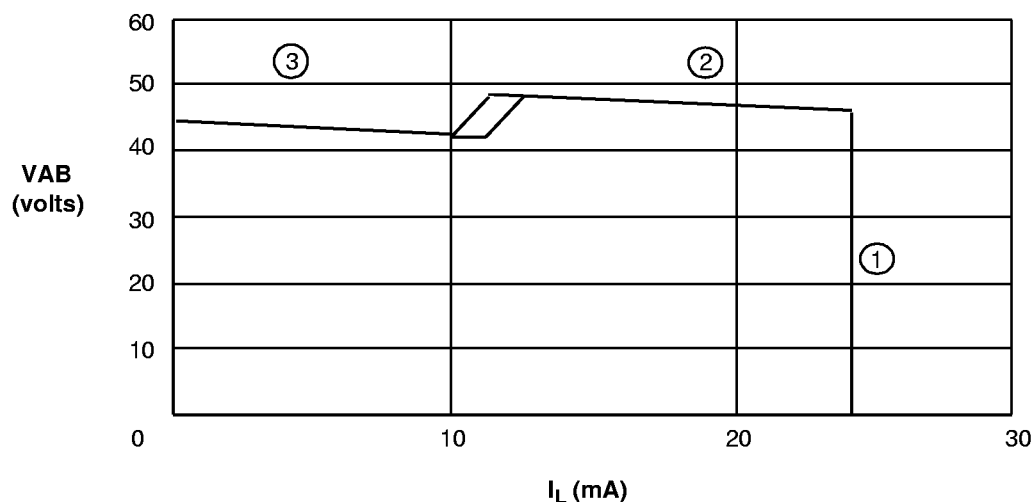
**Note:**

Only -1 and -2 performance grade devices support polarity reversal.

**Table 2. User-Programmable Components**

|                                                                                                                   |                                                                                                                                                                                                                                                                                      |
|-------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $Z_T = (250(Z_{2WIN} - 2R_F))$                                                                                    | $Z_T$ is connected between the VTX and RSN pins. The fuse resistors are $R_F$ and $Z_{2WIN}$ is the desired 2-wire AC input impedance. When computing $Z_T$ , the internal current amplifier pole and any external stray capacitance between VTX and RSN must be taken into account. |
| $Z_{RX} = \frac{Z_L}{G_{42L}} \bullet \frac{500Z_T}{Z_T + 250(Z_L + 2R_F)}$                                       | $Z_{RX}$ is connected from $V_{RX}$ to $R_{SN}$ . $Z_T$ is defined above, and $G_{42L}$ is the desired receive gain.                                                                                                                                                                 |
| $R_{DC1} + R_{DC2} = \frac{1250}{I_L}$ $C_{DC} = 1.5 \text{ ms} \bullet \frac{R_{DC1} + R_{DC2}}{R_{DC1}R_{DC2}}$ | $R_{DC1}$ , $R_{DC2}$ , and $C_{DC}$ form the network connected to the RDC pin. $R_{DC1}$ and $R_{DC2}$ are approximately equal. $I_L$ is the desired loop current in the constant-current region.                                                                                   |
| $R_D = \frac{375}{I_T}, \quad C_D = \frac{0.5 \text{ ms}}{R_D}$                                                   | $R_D$ and $C_D$ form the network connected from $R_D$ to GND and $I_T$ is the threshold current between on hook and off hook.                                                                                                                                                        |
| $C_{CAS} = \frac{1}{3.4 \bullet 10^5 \pi f_c}$                                                                    | $C_{CAS}$ is the filter regulator filter capacitor and $f_c$ is the desired filter cutoff frequency.                                                                                                                                                                                 |
| <b>Thermal Management Equations (Normal Active, Polarity Reverse Active, and Tip Open States)</b>                 |                                                                                                                                                                                                                                                                                      |
| $R_{TMG} \geq \frac{ V_{BAT}  - 6 \text{ V}}{I_L}$                                                                | $R_{TMG}$ is connected from $T_{MG}$ to $V_{BAT}$ and is used to limit power dissipation within the SLIC in Active and Tip Open states only.                                                                                                                                         |
| $P_{RTMG} = \frac{( V_{BAT}  - 6 \text{ V} -  I_L \bullet R_L )^2}{R_{TMG}}$                                      | Power dissipated in the resistor, $R_{TMG}$ , during Active and Tip Open states.                                                                                                                                                                                                     |
| $P_{SLIC} =  V_{BAT} \bullet I_L  - P_{RTMG} - R_L(I_L)^2 + 0.12 \text{ W}$                                       | Power dissipated in the SLIC while in Active and Tip Open states.                                                                                                                                                                                                                    |

## DC FEED CHARACTERISTICS



$$R_{DC} = R_{DC1} + R_{DC2} = 56.8 \text{ k}\Omega$$

### Notes:

$$1. |V_{BAT}| < 48 \text{ V}, OVH = 1$$

$$|V_{BAT}| < 52 \text{ V}, OVH = 0$$

$$VAB_1 = \frac{1250}{R_{DC}} \cdot R_L$$

$$VAB_1 = \frac{1250}{R_{DC}} \cdot R_L$$

$$VAB_2 = 0.818 \cdot |V_{BAT}| + 5.356 - I_L \cdot \frac{R_{DC}}{369}$$

$$VAB_2 = 0.818 \cdot |V_{BAT}| + 5.356 - I_L \cdot \frac{R_{DC}}{369}$$

$$VAB_3 = 0.818 \cdot |V_{BAT}| + 2.740 - I_L \cdot \frac{R_{DC}}{359}$$

$$VAB_3 = 0.818 \cdot |V_{BAT}| + 2.740 - I_L \cdot \frac{R_{DC}}{359}$$

$$2. |V_{BAT}| \geq 48 \text{ V}, OVH = 1$$

$$VAB_1 = \frac{1250}{R_{DC}} \cdot R_L$$

$$VAB_2 = 0.818 \cdot |V_{BAT}| - 2.276 - I_L \cdot \frac{R_{DC}}{369} + \frac{18587 + \left( R_{SG} + \frac{35500}{|V_{BAT}| - 48} \right)}{1777 + 0.131 \cdot \left( R_{SG} + \frac{35500}{|V_{BAT}| - 48} \right)}$$

$$VAB_3 = 0.818 \cdot |V_{BAT}| - 4.894 - I_L \cdot \frac{R_{DC}}{359} + \frac{18587 + \left( R_{SG} + \frac{35466}{|V_{BAT}| - 48} \right)}{1777 + 0.131 \cdot \left( R_{SG} + \frac{35466}{|V_{BAT}| - 48} \right)}$$

### a. Load Line (Typical)

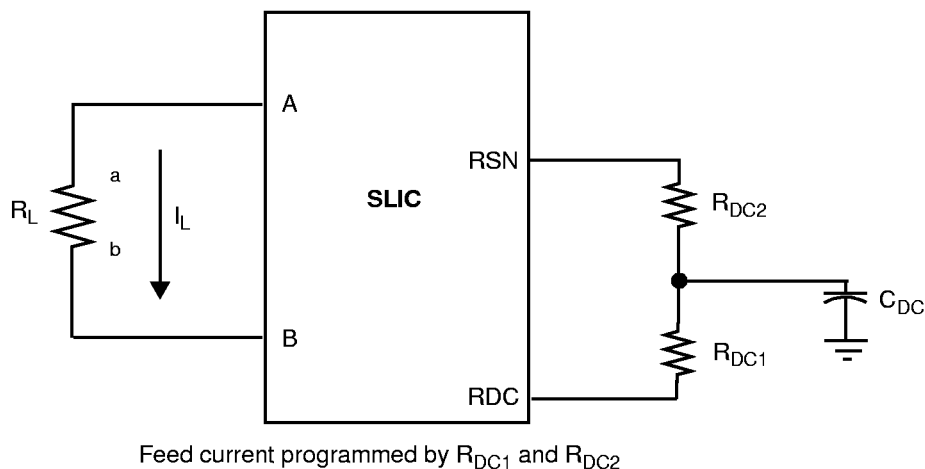
## DC FEED CHARACTERISTICS (continued)

3.  $|V_{BAT}| \geq 52 \text{ V}$ , OVH = 0

$$VAB_1 = \frac{1250}{R_{DC}} \cdot R_L \text{ where } R_L = R_{LOAD} + R_{FUSE}$$

$$VAB_2 = 0.904 \cdot |V_{BAT}| - 11.031 - I_L \cdot \frac{R_{DC}}{369} + \frac{18587 + \left( R_{SG} + \frac{174000}{|V_{BAT}| - 48} \right)}{1777 + 0.131 \cdot \left( R_{SG} + \frac{174000}{|V_{BAT}| - 48} \right)}$$

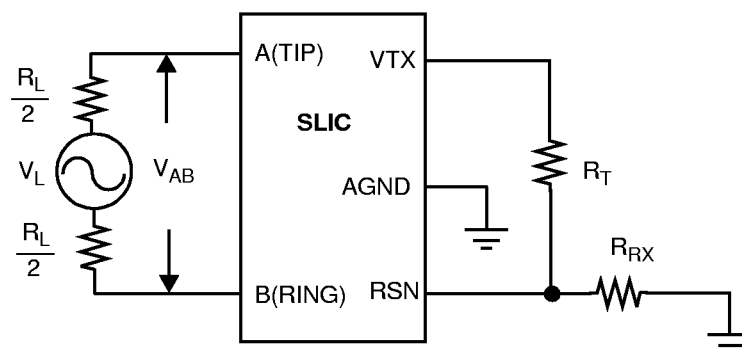
$$VAB_3 = 0.904 \cdot |V_{BAT}| - 13.649 - I_L \cdot \frac{R_{DC}}{359} + \frac{18587 + \left( R_{SG} + \frac{174000}{|V_{BAT}| - 48} \right)}{1777 + 0.131 \cdot \left( R_{SG} + \frac{174000}{|V_{BAT}| - 48} \right)}$$



### b. Feed Programming

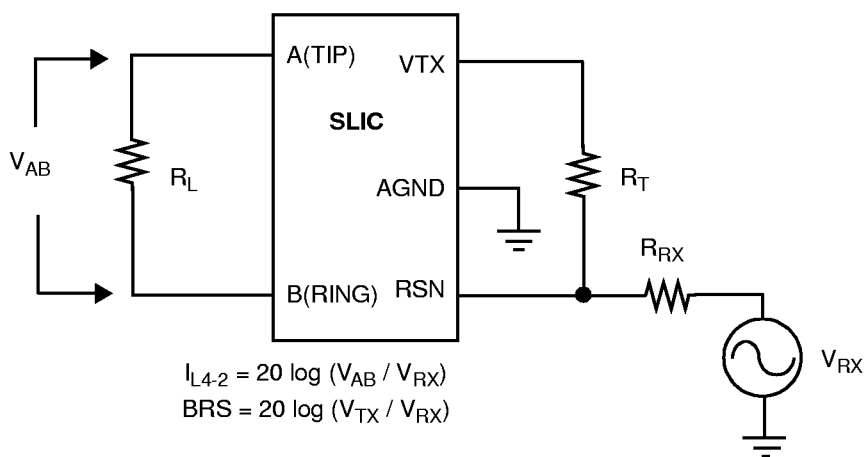
**Figure 1. DC Feed Characteristics**

## TEST CIRCUITS



$$I_{L2-4} = 20 \log (V_{TX} / V_{AB})$$

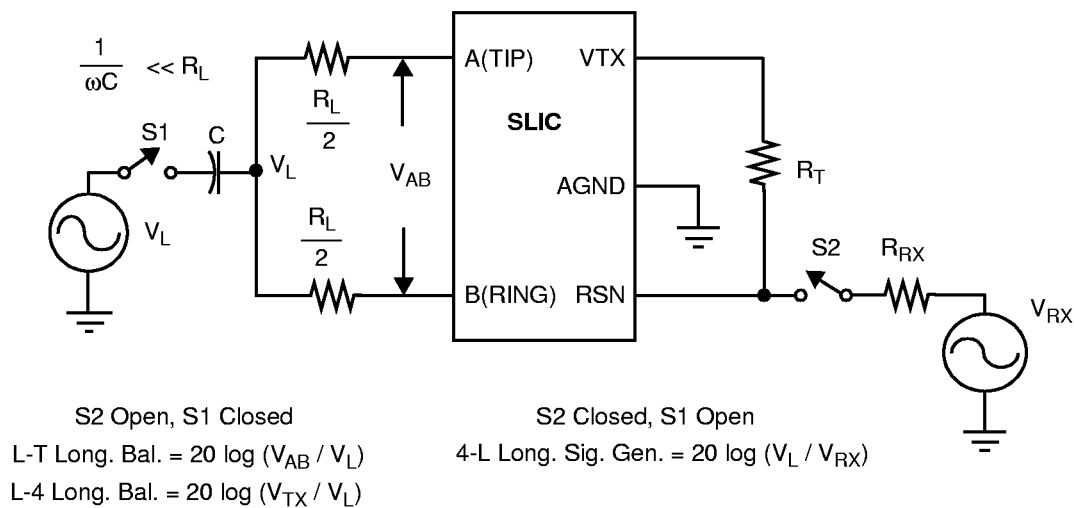
**A. Two- to Four-Wire Insertion Loss**



$$I_{L4-2} = 20 \log (V_{AB} / V_{RX})$$

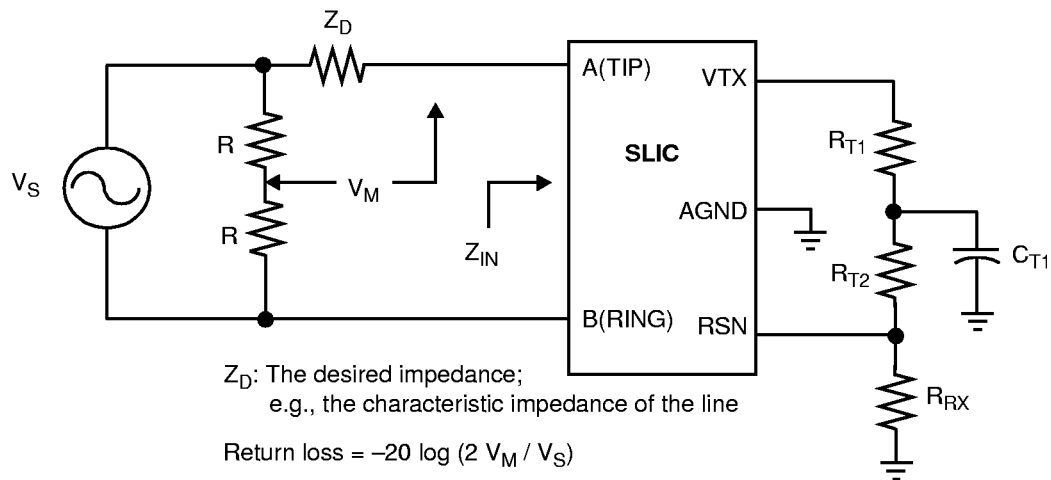
$$BRS = 20 \log (V_{TX} / V_{RX})$$

**B. Four- to Two-Wire Insertion Loss and Balance Return Signal**

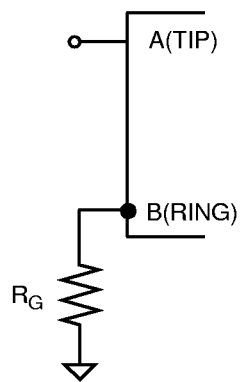


**C. Longitudinal Balance**

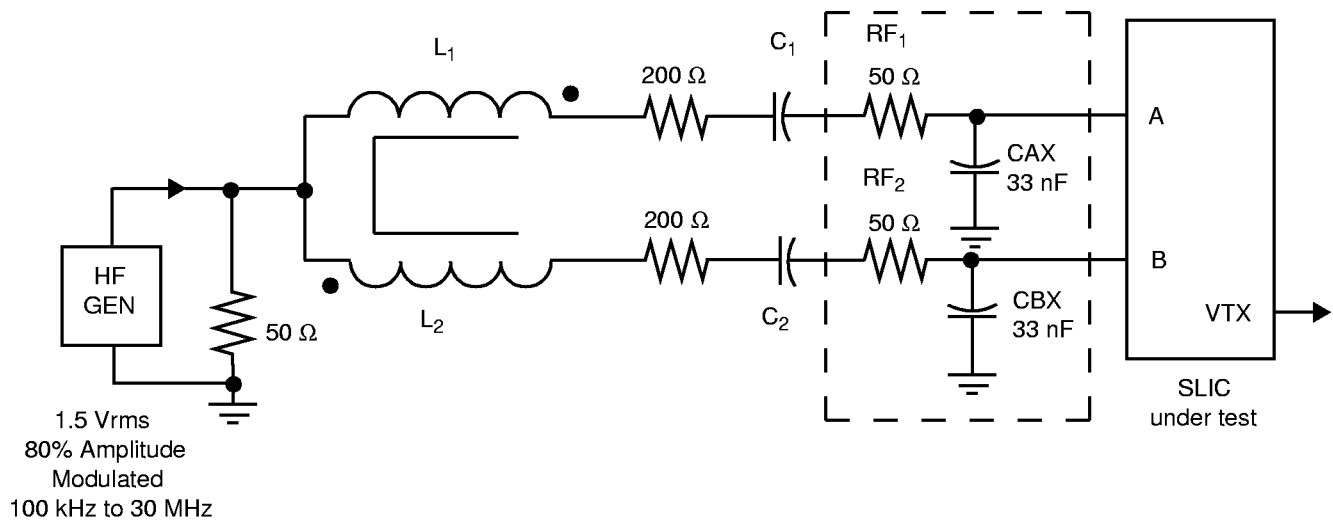
## TEST CIRCUITS (continued)



**D. Two-Wire Return Loss Test Circuit**

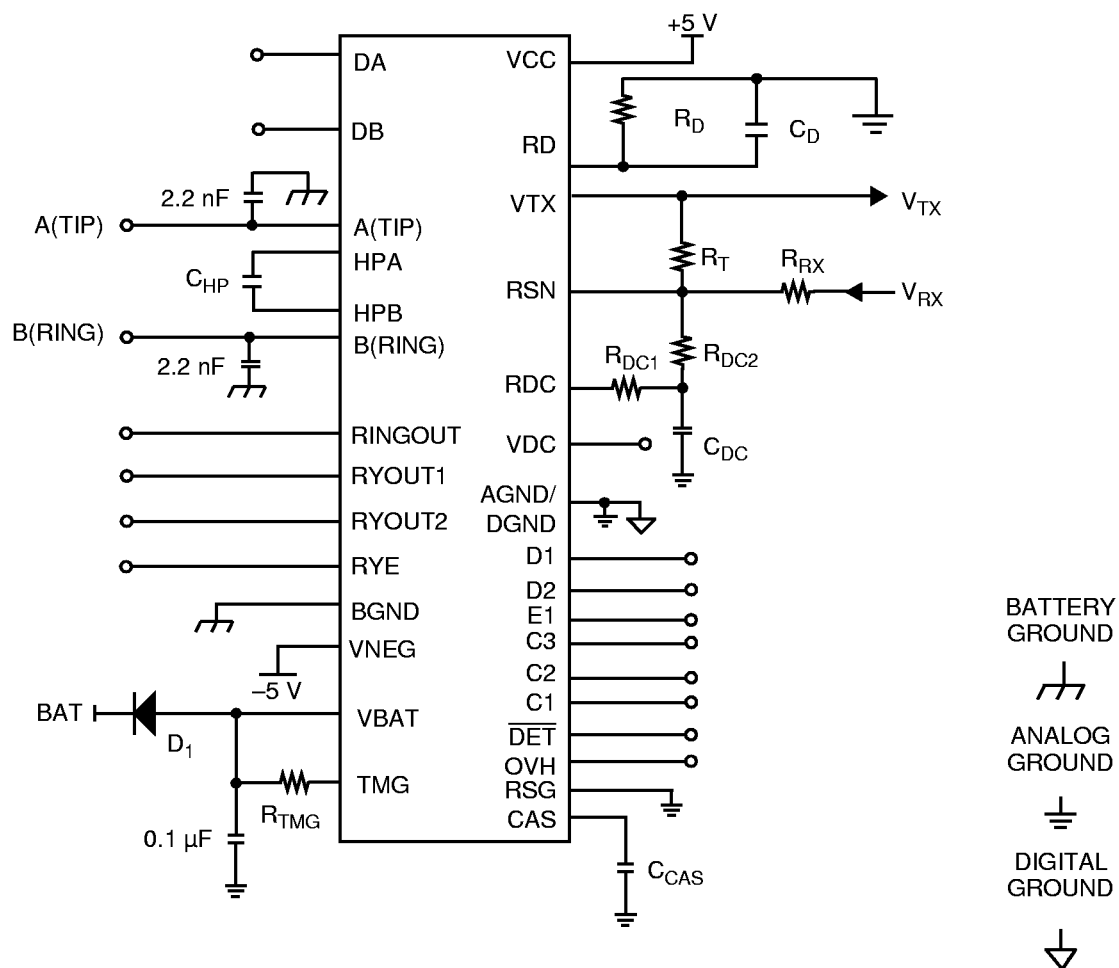


**E. Ground-Key Switching**



**F. RFI Test Circuit**

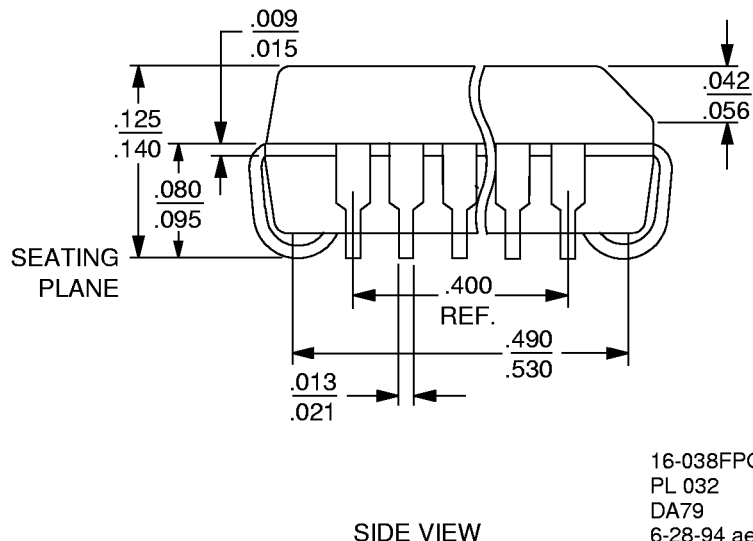
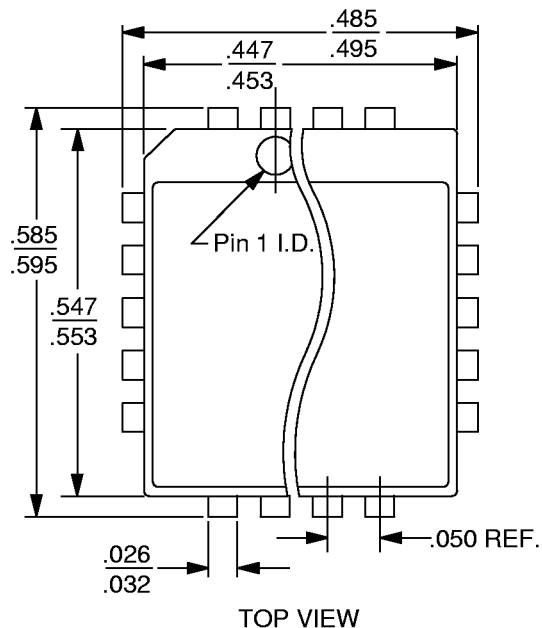
## TEST CIRCUITS (continued)



**G. Am7946 Test Circuit**

## PHYSICAL DIMENSION

### PL032



16-038FPO-5  
PL 032  
DA79  
6-28-94 ae

## REVISION SUMMARY

### Revision A to B

- Minor changes were made to the data sheet style and format to conform to AMD standards.

### Revision B to Revision C

- In Table 2, User-Programmable Components, added "Polarity Reverse Active" to the "Thermal Management..." header.
- Minor changes were made to the data sheet style and format to conform to AMD standards.

### Revision C to Revision D

- The physical dimension (PL032) was added to the Physical Dimension section.
- Updated the Pin Description table to correct inconsistencies.